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NCP5381A

2/3/4 Phase Buck Controller for VR10 and VR11 Pentium IV Processor Applications

The NCP5381A is a two-, three-, or four-phase buck controller which combines differential voltage and current sensing, and adaptive voltage positioning to power Intel's most demanding Pentium® IV Processors and low voltage, high current power supplies. Dual-edge pulse-width modulation (PWM) combined with inductor current sensing reduces system cost by providing the fastest initial response to transient loads thereby requiring less bulk and ceramic output capacitors to satisfy transient load-line requirements.

A high performance operational error amplifier is provided, which allows easy compensation of the system. The proprietary method of Dynamic Reference Injection makes the error amplifier compensation virtually independent of the system response to VID changes, eliminating the need for tradeoffs between load transients and Dynamic VID performance.

Features

- Meets Intel's VR 10.0, 10.1, 10.2, and 11.0 Specifications
- Dual-Edge PWM for Fastest Initial Response to Transient Loading
- High Performance Operational Error Amplifier
- Supports both VR11 and Legacy VR10 Soft-Start Modes
- Dynamic Reference Injection
- 8-Bit DAC per Intel's VR11 Specifications
- DAC Range from 0.5 V to 1.6 V
- ±0.5% System Voltage Accuracy
- Remote Temperature Sensing per VR11
- 2, 3, or 4-Phase Operation
- True Differential Remote Voltage Sensing Amplifier
- Phase-to-Phase Current Balancing
- "Lossless" Differential Inductor Current Sensing
- Differential Current Sense Amplifiers for each Phase
- Adaptive Voltage Positioning (AVP)
- Fixed No-Load Voltage Positioning at –19 mV
- Frequency Range: 100 kHz–1.0 MHz
- Latched Overvoltage Protection (OVP)
- Threshold Sensitive Enable Pin for VTT Sensing
- Power Good Output with Internal Delays
- Programmable Soft-Start Time
- Operates from 12 V
- This is a Pb-Free Device*

Applications

- Pentium IV Processors
- VRM Modules
- Graphics Cards
- Low Voltage, High Current Power Supplies

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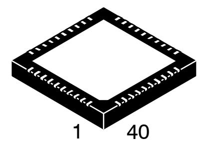
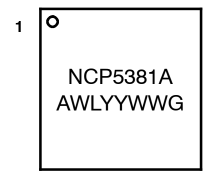


40 PIN QFN, 7x7
MN SUFFIX
CASE 488AG

MARKING DIAGRAM



NCP5381A = Specific Device Code
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

*Pin 41 is the thermal pad on the bottom of the device.

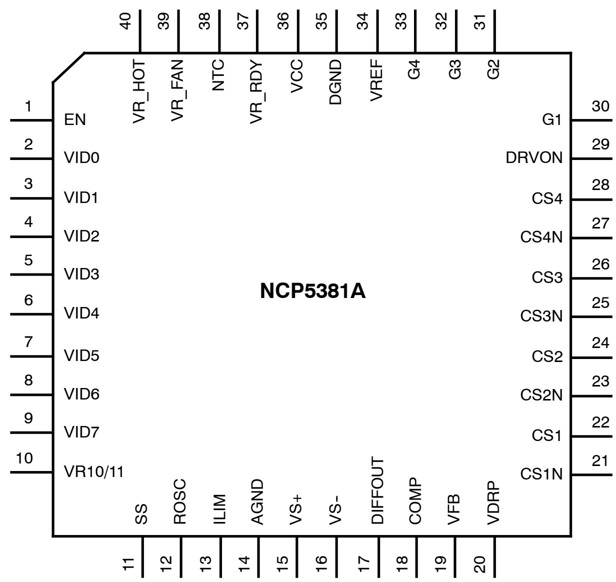
ORDERING INFORMATION

Device	Package	Shipping†
NCP5381AMNR2G	QFN-40 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PIN CONNECTIONS



(Top View)

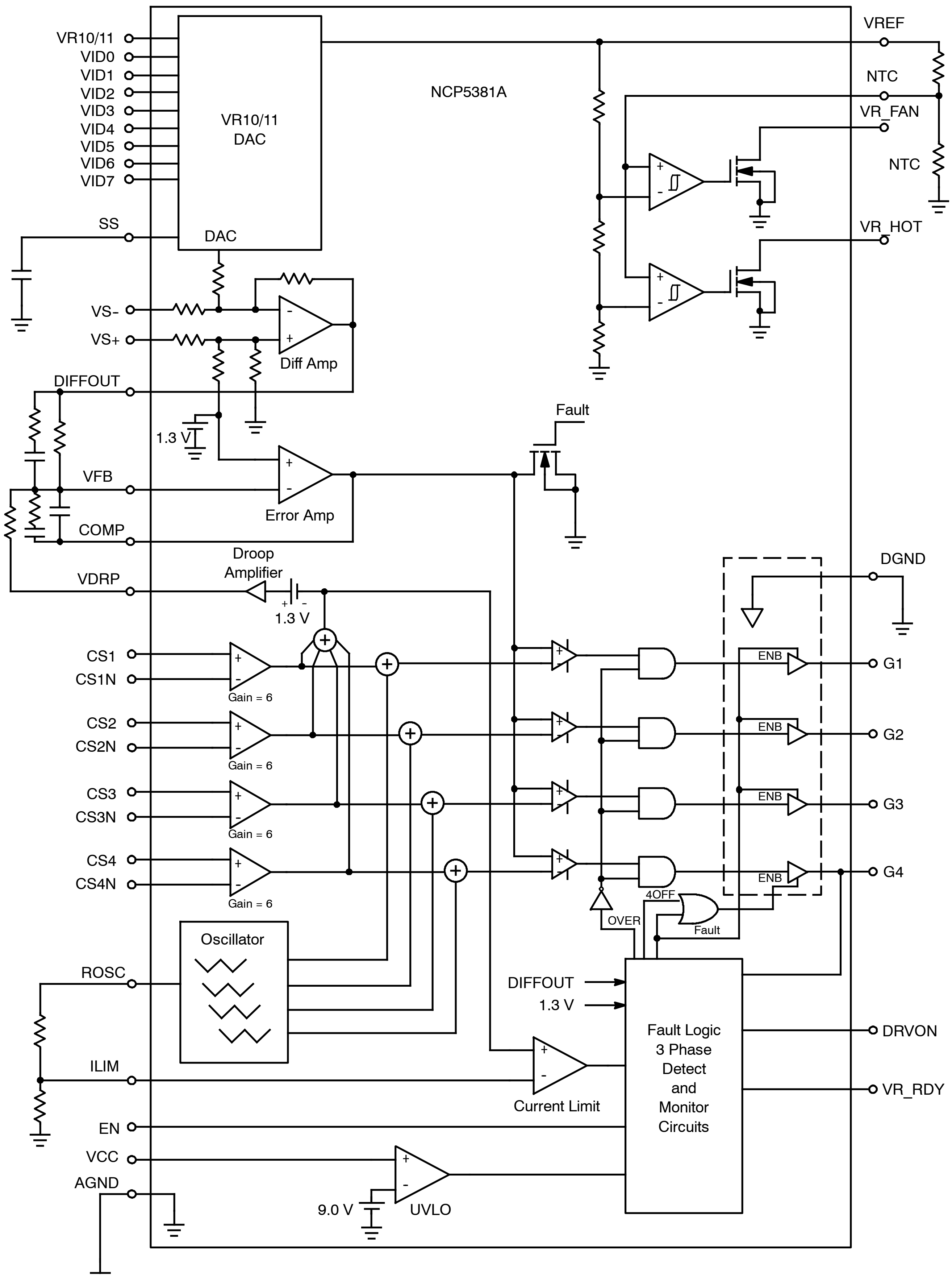


Figure 1. Simplified Block Diagram

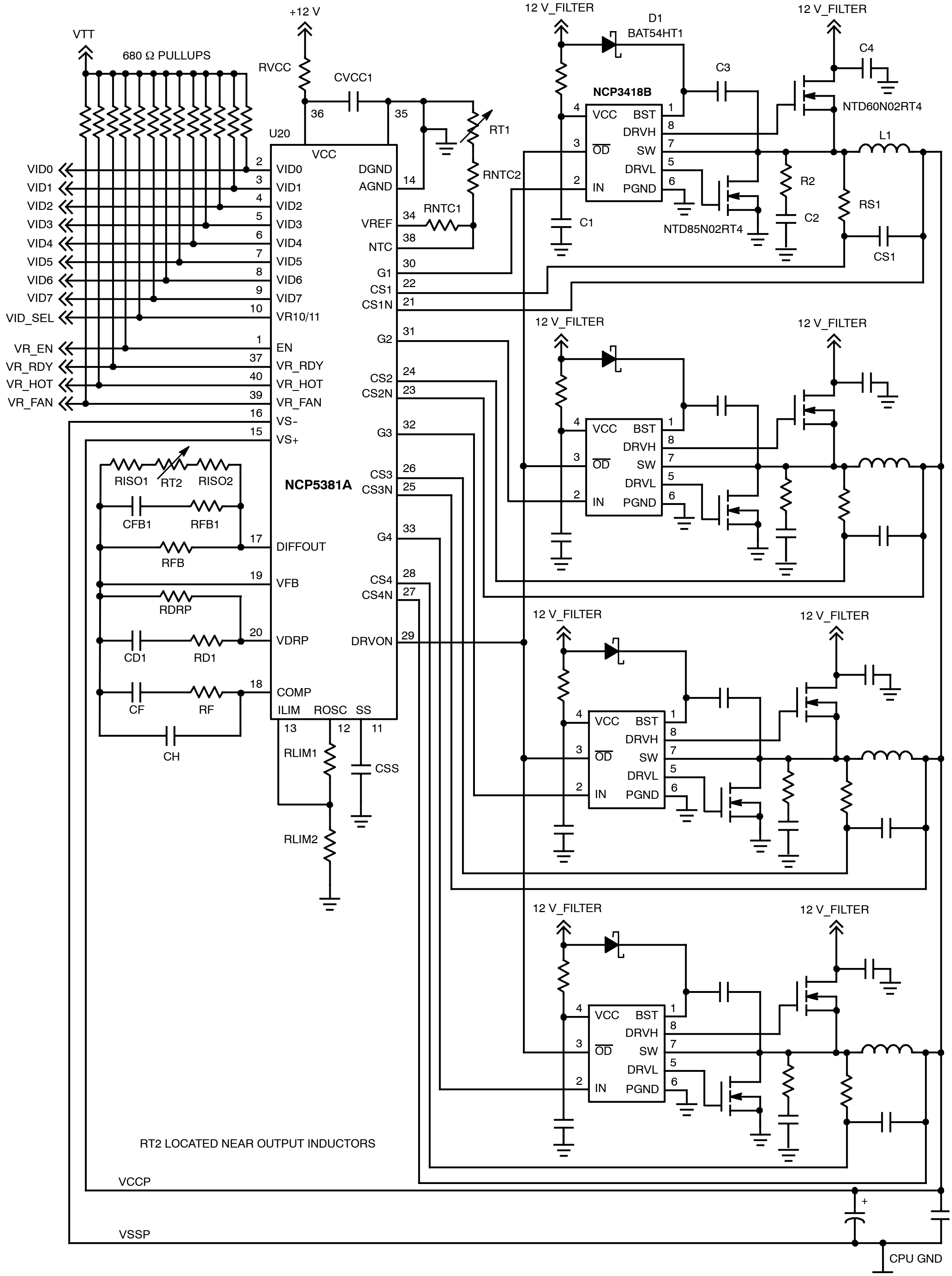


Figure 2. Application Schematic for Four Phases

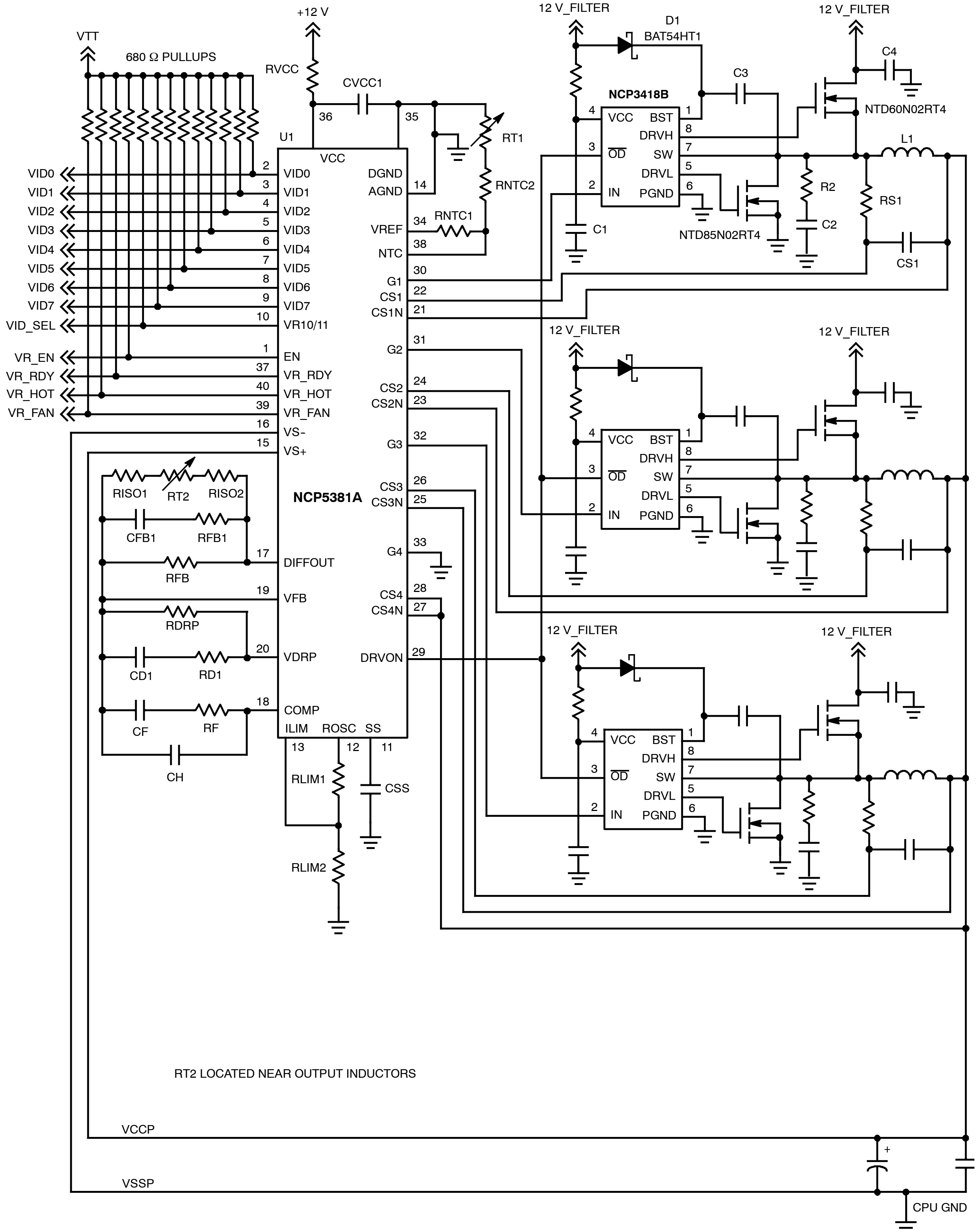


Figure 3. Application Schematic for Three Phases

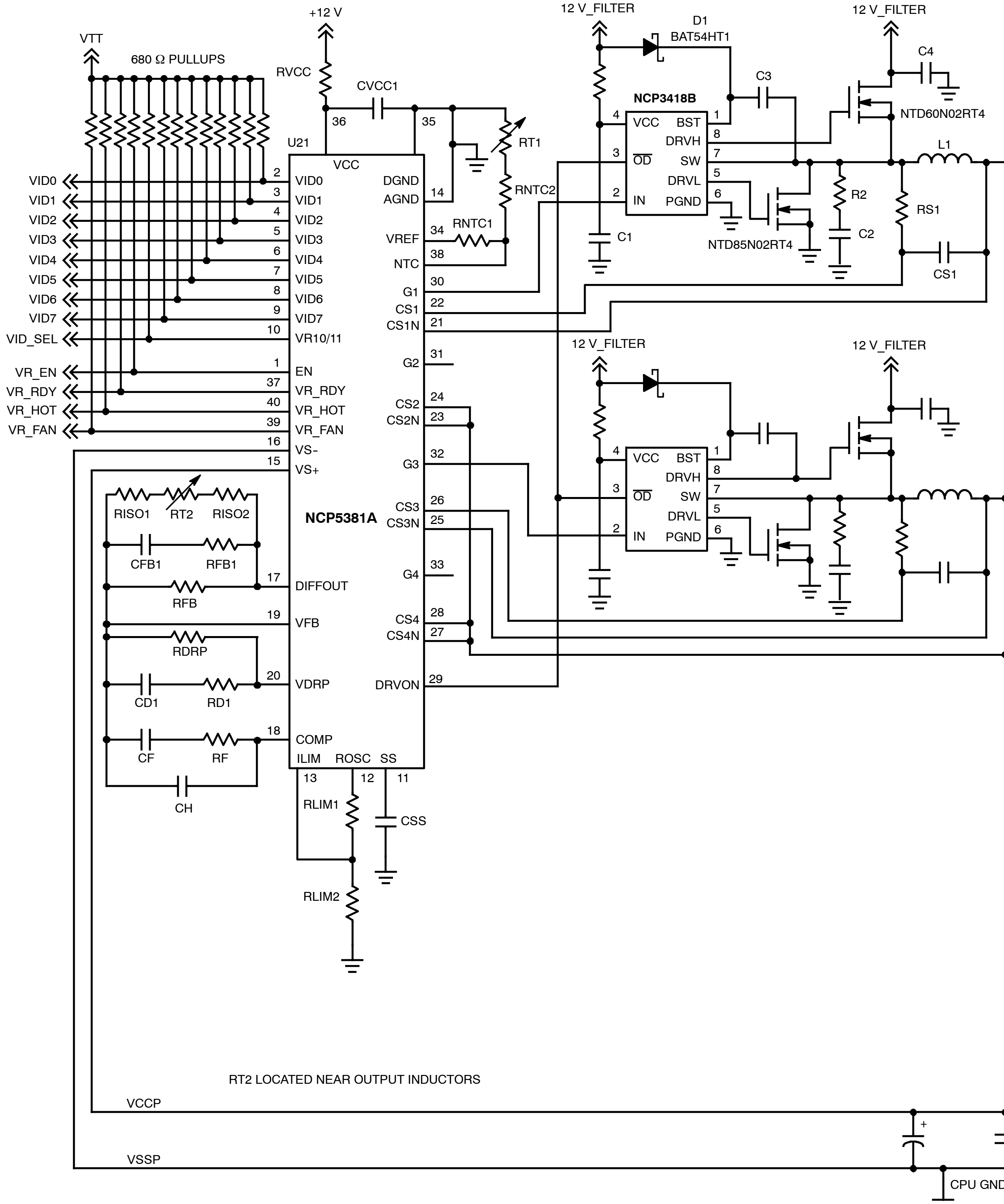


Figure 4. Application Schematic for Two Phases

PIN DESCRIPTIONS

Pin No.	Symbol	Description
1	EN	Pull this pin high to enable controller. Pull this pin low to disable controller. Either an open-collector output (with a pull-up resistor) or a logic gate (CMOS or totem-pole output) may be used to drive this pin. A Low to High transition on this pin will initiate a soft start. If the Enable function is not required, this pin should be tied directly to VREF.
2 – 9	VID0–VID7	Voltage ID DAC inputs.
10	VR10/VR11	VR select bit. Connect this pin to VTT (1.25 V) to select the VR11 DAC table. Ground this pin to select the VR10 DAC table with VR11 type startup. Connect this pin to V_{REF} (4 V) to select VR10 DAC table with legacy VR10 type startup.
11	SS	A capacitor from this pin to ground programs the soft-start time.
12	ROSC	A resistance from this pin to ground programs the oscillator frequency. Also, this pin supplies a regulated 2.0 V which may be used with a voltage divider to the ILIM pin to set the over current shutdown threshold as shown in the Applications Schematics.
13	ILIM	Over current shutdown threshold. To program the shutdown threshold, connect this pin to the R_{OSC} pin via a resistor divider as shown in the Applications Schematics. To disable the over current feature connect this pin directly to the R_{OSC} pin. To guarantee correct operation, this pin should only be connected to the voltage generated by the R_{OSC} pin – do not connect this pin to any externally generated voltages.
14	AGND	Power supply return for the analog circuits that control output voltage.
15	VS+	Non-inverting input to the internal differential remote V_{CORE} sense amplifier.
16	VS-	Inverting input to the internal differential remote V_{CORE} sense amplifier.
17	DIFFOUT	Output of the differential remote sense amplifier.
18	COMP	Output of the error amplifier.
19	VFB	Error amplifier inverting input. Connect a resistor from this pin to DIFFOUT. The value of this resistor and the amount of current from the droop resistor (R_{DRP}) will set the amount of output voltage droop (AVP) during load.
20	VDRP	Current signal output for Adaptive Voltage Positioning (AVP). The voltage of this pin minus 1.3 V is proportional to the output current. Connect a resistor from this pin to V_{FB} to set the amount of AVP current into the feedback resistor (R_{FB}) to produce an output voltage droop. Leave this pin open for no AVP.
21, 23, 25, 27	CSxN	Inverting input to current sense amplifier #x, x = 1, 2, 3, 4.
22, 24, 26, 28	CSx	Non-inverting input to current sense amplifier #x, x = 1, 2, 3, 4.
29	DRVON	Gate Driver enable output. This pin produces a logic HIGH to enable gate drivers and a logic LOW to disable gate drivers and has an internal 70 kΩ to ground.
30 – 33	G1 – G4	PWM control signal outputs to gate drivers.
34	VREF	Voltage reference pin. This pin may be used to implement remote NTC temperature sensing as shown in the Applications Schematic.
35	DGND	Power supply return for the digital circuits. Connect to AGND.
36	VCC	Power for the internal control circuits.
37	VR_RDY	Voltage Regulator Ready (PowerGood) output. Open drain type output with internal delays that will transition High when V_{CORE} is higher than 300 mV below DAC, Low when V_{CORE} is lower than 380 mV below DAC, and Low when V_{CORE} is higher than DAC+185 mV. This output is latched Low if V_{CORE} exceeds DAC+185 mV until V_{CC} is removed.
38	NTC	Remote temperature sense connection. Connect an NTC thermistor from this pin to GND and a resistor from this pin to V_{REF}. As the NTC's temperature increases the voltage on this pin will decrease.
39	VR_FAN	Open drain type of output that will be low impedance when the voltage at the NTC pin is above 1.416 V. This pin will transition to a high impedance state when the voltage at the NTC pin decreases below 1.176 V.
40	VR_HOT	Open drain type of output that will be low impedance when the voltage at the NTC pin is above 1.086 V. This pin will transition to a high impedance state when the voltage at the NTC pin decreases below 0.846 V.
41	THPAD	Copper pad on the bottom of the IC for heatsinking. This pin should be connected to the ground plane under the IC.

MAXIMUM RATINGS

Rating	Value	Unit
Operating Ambient Temperature Range	0 to 70	°C
Operating Junction Temperature Range	0 to 85	°C
Storage Temperature Range	-55 to 150	°C
Lead Temperature Soldering, Reflow (60 to 120 seconds minimum above 237°C):	260	°C
Thermal Resistance, Junction-to-Ambient ($R_{\theta JA}$) on a thermally conductive PCB in free air	83	°C/W
JEDEC Moisture Sensitivity Level	≤ 3	MSL
Maximum Voltage – VCC pin with respect to AGND	15	V
Maximum Voltage – all other pins with respect to AGND	5.5	V
Minimum Voltage – all pins with respect to AGND	-0.3	V
Maximum Current into pins: COMP, VDRP, DIFFOUT, VREF	3.0	mA
Maximum Current into pins: VR_RDY, G1, G2, G3, G4, SS, VR_FAN, VR_HOT, DRVON	20	mA
Maximum Current out of pins: COMP, VDRP, DIFFOUT, ROSC, VREF	3.0	mA
Maximum Current out of pins: G1, G2, G3, G4	20	mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

NOTE: ESD Sensitive Device.

ELECTRICAL CHARACTERISTICS
(0°C < T_A < 70°C; 0°C < T_J < 85°C; 10.8 V < V_{CC} < 13.2 V; All DAC Codes; C_{VCC} = 0.1 μF, F_{SW} = 400 kHz, unless otherwise stated)

Parameter	Test Conditions	Min	Typ	Max	Units
Error Amplifier					
Input Bias Current		−200	−50	−10	nA
Inverting Input Voltage	1.0 kΩ between VFB and COMP Pins	−	1.3	−	V
Input Offset Voltage (Note 1)		−1.0	−	1.0	mV
Open Loop DC Gain (Note 1)	C_L = 60 pF to GND, R_L = 10 kΩ to GND	−	78	−	dB
Open Loop Unity Gain Bandwidth (Note 1)	C_L = 60 pF to GND, R_L = 10 kΩ to GND	−	15	−	MHz
Open Loop Phase Margin (Note 1)	C_L = 60 pF to GND, R_L = 10 kΩ to GND	−	65	−	deg
Slew Rate (Note 1)	ΔV_{in} = 100 mV, G = −1.0 V/V, 1.2 V < V_{out} < 2.2 V, C_L = 60 pF, DC Load = ±125 μA	−	5.0	−	V/μs
Maximum Output Voltage	I_{SOURCE} = 1.0 mA	3.0	3.3	−	V
Minimum Output Voltage	I_{SINK} = 1.0 mA	−	0.9	1.0	V
Output Source Current (Note 1)	V_{out} = 3.0 V	−	2.0	−	mA
Output Sink Current (Note 1)	V_{out} = 1.0 V	−	2.0	−	mA
Remote Sense Differential Amplifier					
VS+ Input Resistance (Note 1)	DRVON = High DRVON = Low	− −	17 0.5	− −	kΩ
VS+ Input Open Circuit Voltage (Note 1)	DRVON = High DRVON = Low	− −	0.67 0.05	− −	V
VS− Input Resistance (Note 1)	VS+ = DAC Voltage DRVON = High	−	10	−	kΩ
VS− Input Open Circuit Voltage (Note 1)	DRVON = High VS+ = DAC Voltage		= 0.333*DAC + 0.433		V
Input Voltage Range		−0.3	−	3.0	V
Input Offset Voltage (Note 1)		−1.0	−	1.0	mV
−3dB Bandwidth (Note 1)	C_L = 80 pF to GND, R_L = 10 kΩ to GND	−	12	−	MHz
DC Gain	$I_{DIFFOUT}$ = 100 μA	0.982	1.000	1.018	V/V
Slew Rate (Note 1)	ΔV_{in} = 1.0 V, ΔV_{out} = 1.0 V to 2.0 V, C_L = 80 pF to GND, Load = ±125 μA	−	10	−	V/μs
Maximum Output Voltage	I_{SOURCE} = 1.0 mA	3.0	−	−	V
Minimum Output Voltage	I_{SINK} = 1.0 mA	−	−	0.5	V
Output Source Current (Note 1)	V_{out} = 2.1 V	−	25	−	mA
Output Sink Current (Note 1)	V_{out} = 1.0 V	−	1.4	−	mA

1. Guaranteed by design. Not tested in production.

ELECTRICAL CHARACTERISTICS

(0°C < T_A < 70°C; 0°C < T_J < 85°C; 10.8 V < V_{CC} < 13.2 V; All DAC Codes; C_{VCC} = 0.1 μF, F_{SW} = 400 kHz, unless otherwise stated)

Parameter	Test Conditions	Min	Typ	Max	Units
V_{DRP} Adaptive Voltage Positioning Amplifier					
Current Sense Input to V_{DRP} Gain	-60 mV < (CSx-CSxN) < +60 mV, T_A = 25°C	5.7	6.0	6.3	V/V
Current Sense Input to V_{DRP} Output -3dB Bandwidth (Note 1)	C_L = 330 pF to GND, R_L = 10 kΩ to GND	-	7.2	-	MHz
Current Sense Input to V_{DRP} Output Slew Rate (Note 1)	ΔV(CSx-CSxN) = 25 mV (all phases), 1.3 V < V_{out} < 1.9 V, C_L = 330 pF to GND, Load = ±400 μA	-	3.7	-	V/μs
Current Summing Amp Output Offset Voltage	CSx – CSxN = 0, CSx =1.0 V	-15	-	+15	mV
Maximum V_{DRP} Output Voltage	CSx - CSxN = 0.12 V (all phases), I_{SOURCE} = 1.0 mA	3.02	-	-	V
Minimum V_{DRP} Output Voltage	CSx - CSxN = -0.12 V (all phases), I_{SINK} = 1.0 mA	-	-	0.5	V
Output Source Current (Note 1)	VDRP = 2.9 V	-	9.0	-	mA
Output Sink Current (Note 1)	VDRP = 1.0 V	-	2.0	-	mA
Current Sense Amplifiers					
Input Bias Current	CSx = CSxN = 1.4 V	-200	-100	-	nA
Common Mode Input Voltage Range (Note 1)		-0.3	-	2.0	V
Differential Mode Input Voltage Range		-120	-	120	mV
Input Offset Voltage (Note 1)	CSx = CSxN = 1.0 V	-3.0	-	3.0	mV
Current Sense Input to PWM Comparator Input Gain	0 mV < (CSx-CSxN) < 25 mV T_A = 25°C	5.7	6.0	6.3	V/V
Oscillator					
Switching Frequency Range (Note 1)		100	-	1000	kHz
Switching Frequency Accuracy (Note 1)	R_{OSC} = 100 kΩ, 2 or 4-phase	93.6	104	114.4	kHz
Switching Frequency Accuracy	R_{OSC} = 49.9 kΩ, 2 or 4-phase	184.5	205	225.5	kHz
Switching Frequency Accuracy	R_{OSC} = 24.9 kΩ, 2 or 4-phase	360	400	440	kHz
Switching Frequency Accuracy	R_{OSC} = 10 kΩ, 2 or 4-phase	829	921	1013	kHz
Switching Frequency Accuracy (Note 1)	R_{OSC} = 100 kΩ, 3-phase	90	100	110	kHz
Switching Frequency Accuracy	R_{OSC} = 49.9 kΩ, 3-phase	178.2	198	217.8	kHz
Switching Frequency Accuracy	R_{OSC} = 24.9 kΩ, 3-phase	351	390	429	kHz
Switching Frequency Accuracy	R_{OSC} = 10 kΩ, 3-phase	818	909	1000	kHz
R_{OSC} Output Voltage	10 kΩ < R_{OSC} < 49.9 kΩ	1.92	2.00	2.08	V
R_{OSC} Output Voltage (Note 1)	49.9 kΩ < R_{OSC} < 100 kΩ	-	2.00	-	V

1. Guaranteed by design. Not tested in production.

ELECTRICAL CHARACTERISTICS
($0°C < T_A < 70°C$; $0°C < T_J < 85°C$; $10.8 V < V_{CC} < 13.2 V$; All DAC Codes; C_{VCC} = 0.1 μF, F_{SW} = 400 kHz, unless otherwise stated)

Parameter	Test Conditions	Min	Typ	Max	Units
Modulators (PWM Comparators)					
Minimum Pulse Width	Fs = 400 kHz	-	30	40	ns
Magnitude of the PWM Ramp		-	1.0	-	V
0% Duty Cycle	COMP voltage when the PWM outputs remain LO	-	1.2	-	V
100% Duty Cycle	COMP voltage when the PWM outputs remain HI	-	2.3	-	V
Minimum PWM Linear Duty Cycle (Note 1)	F_S = 400 kHz	-	90	-	%
PWM Comparator Offset Mismatch (Note 1)	Between any 2 phases, F_S = 400 kHz	-	-	40	mV
Phase Angle Error	Between adjacent phases, F_S = 400 kHz	−15	-	15	°
Propagation Delay (Note 1)	Ramp/Comp crossing to Gx high	-	20	-	ns
Propagation Delay (Note 1)	Ramp/Comp crossing to Gx low	-	20	-	ns
PWM Outputs					
Output High Voltage	Sourcing 500 μA	3.3	4.0	4.7	V
Output Low Voltage	Sinking 500 μA	-	25	100	mV
Rise Time	C_L = 20 pF, ΔVo = 0.3 to 2.0 V	-	10	-	ns
Fall Time	C_L = 20 pF, ΔVo = Vmax to 0.7 V	-	10	-	ns
Output Impedance – LO State	Resistance to GND (Gx = LO)	-	50	-	Ω
G4 Gate Pin Source Current during Phase Detect		-	70	-	μA
Phase Detection Period		-	50	-	μs
G4 Phase Detect Threshold Resistance		-	-	1.0	kΩ
Gate Driver Enable (DRVON)					
Output High Voltage	Sourcing 500 μA	4.0	5.3	5.5	V
Output Low Voltage	Sinking 500 μA	-	50	200	mV
Rise Time	C_L (PCB) = 20 pF, ΔVo = 10% to 90%	-	25	-	ns
Fall Time	C_L (PCB) = 20 pF, ΔVo = 10% to 90%	-	25	-	ns
Internal Pulldown Resistance	V_{CC} < UVLO Threshold	-	70	140	kΩ

1. Guaranteed by design. Not tested in production.

ELECTRICAL CHARACTERISTICS

(0°C < T_A < 70°C; 0°C < T_J < 85°C; 10.8 V < V_{CC} < 13.2 V; All DAC Codes; C_{VCC} = 0.1 μF, F_{SW} = 400 kHz, unless otherwise stated)

Parameter	Test Conditions	Min	Typ	Max	Units
VR_RDY (Power Good) Output					
Saturation Voltage	I_{SINK} = 10 mA	-	-	0.4	V
Rise Time	External pullup of 1.0 kΩ to 1.25 V, C_{LOAD} = 20 pF, ΔVo = 10% to 90%	-	-	150	ns
Output Voltage at Power-up (Note 1)	External VR_RDY pullup resistor of 2.0 kΩ to 5.0 V, $t_{R\_VCC} \le 3 \times t_{R\_5V}$, 100 μs ≤ t_{R_VCC} ≤ 20 ms	-	-	1.0	V
High – Output Leakage Current	VR_RDY = 5.5 V via 1.0 K	-	-	1.0	μA
Upper Threshold Voltage	VCORE increasing, DAC = 1.3 V	-	300	-	mV below DAC
Rising Delay	VCORE increasing	0.3	1.40	2.0	ms
Falling Delay	VCORE decreasing	-	5.0	-	μs
VR_FAN AND VR_HOT					
NTC Pin Bias Current	0 V < NTC < 5.0 V	-1.0	-	1.0	μA
VR_FAN Upper Voltage Threshold	Fraction of VREF voltage above which VR_FAN output pulls low	0.3518	0.3625	0.3737	
VR_FAN Lower Voltage Threshold	Fraction of VREF voltage below which VR_FAN output is open	0.2892	0.3025	0.3112	
VR_FAN Hysteresis		210	240	270	mV
VR_FAN Output Voltage at Powerup (Note 1)	External Pullup resistor of 2.0 kΩ to 5.0 V, $t_{R\_VCC} \le 3 \times t_{R\_5V}$, 100 μs ≤ t_{R_VCC} ≤ 20 ms	-	-	1.0	V
VR_FAN Output Saturation Voltage	I_{SINK} = 4.0 mA	-	-	0.3	V
VR_FAN Output Leakage Current	High Impedance State, VR_FAN = 5.0 V	-	-	1.0	μA
VR_HOT Upper Voltage Threshold	Fraction of VREF voltage above which VR_HOT output pulls low	0.2732	0.2815	0.2897	
VR_HOT Lower Voltage Threshold	Fraction of VREF voltage below which VR_HOT output is open	0.2107	0.2190	0.2272	
VR_HOT Hysteresis		210	240	270	mV
VR_HOT Output Voltage at Powerup (Note 1)	External Pullup resistor of 2.0 kΩ to 5.0 V, $t_{R\_VCC} \le 3 \times t_{R\_5V}$, 100 μs ≤ t_{R_VCC} ≤ 20 ms	-	-	1.0	V
VR_HOT Saturation Output Voltage	I_{SINK} = 4.0 mA	-	-	0.3	V
VR_HOT Output Leakage Current	High Impedance State, VR_HOT = 5.0 V	-	-	1.0	μA

1. Guaranteed by design. Not tested in production.

ELECTRICAL CHARACTERISTICS
(0°C < T_A < 70°C; 0°C < T_J < 85°C; 10.8 V < V_{CC} < 13.2 V; All DAC Codes; C_{VCC} = 0.1 μF, F_{SW} = 400 kHz, unless otherwise stated)

Parameter	Test Conditions	Min	Typ	Max	Units
Soft-Start					
SS Pin Source Current	ENABLE = HI, $V_{SS\ PIN}$ < 1.1 V	-	5.0	-	μA
SS Pin Source Current	ENABLE = HI, $V_{SS\ PIN}$ > 1.15 V, VR11 SS mode only	125	-	-	μA
Soft-Start Ramp Time	C_{SS} = 0.01 μF, DRVON = HI to $V_{SS\ PIN}$ = 1.1 V	1.5	2.2	3.0	ms
SS Pin Discharge Voltage	ENABLE = LO	-	-	50	mV
Soft-Start Discharge Time	From ENABLE = LO to $V_{SS\ PIN}$ < max Discharge Voltage, C_{SS} = 0.01 μF	-	5.0	-	μs
VR11 V_{BOOT} Threshold Voltage		-	1.081	-	V
VR11 Dwell Time at V_{BOOT} (Note 1)		50	225	900	μs
Enable Input					
Enable High Input Leakage Current	EN = 3.0 V	-	-	10	μA
Upper Threshold	V_{UPPER}	0.80	0.85	0.90	V
Lower Threshold	V_{LOWER}	0.67	0.75	0.83	V
Total Hysteresis	$V_{UPPER} - V_{LOWER}$	70	100	130	mV
Enable Delay Time	Enable transitioning HI to start of SS voltage rise	0.5	1.5	3.0	ms
Disable Delay Time	Enable transitioning Low to DRVON = Low	-	-	200	ns
Current Limit					
Current Sense Inputs to I_{LIM} Gain (Note 1)	20 mV < (CSx-CSxN) < 60 mV T_A = 25°C (all CS channels together)	5.7	6.0	6.3	V/V
ILIM Pin Input Bias Current	V_{ILIM} = 2.0 V	-	0.1	1.0	μA
ILIM Pin Working Voltage Range (Note 1)		0.3	-	2.0	V
ILIM Input Offset Voltage (Note 1)		-50	-	50	mV
Overvoltage Protection					
Overvoltage Threshold (Note 1)		DAC+160	DAC+180	DAC+200	mV
Undervoltage Protection					
UVLO Start Threshold		8.2	9.0	9.5	V
UVLO Stop Threshold		7.2	8.0	8.5	V
UVLO Hysteresis		-	1.0	-	V
VID Inputs					
Upper Threshold	V_{UPPER}	-	-	800	mV
Lower Threshold	V_{LOWER}	400	-	-	mV
Input Bias Current	V_{VIDX} = 1.25 V	-	100	500	nA
Delay before Latching VID Change (VID De-Skewing)	Measured from the 1^{st} edge of a VID change	400	-	1000	ns

1. Guaranteed by design. Not tested in production.

ELECTRICAL CHARACTERISTICS

(0°C < T_A < 70°C; 0°C < T_J < 85°C; 10.8 V < V_{CC} < 13.2 V; All DAC Codes; C_{VCC} = 0.1 μF, F_{SW} = 400 kHz, unless otherwise stated)

Parameter	Test Conditions	Min	Typ	Max	Units
VR10/VR11 Select					
VR10/VR11 DAC Table Threshold		0.55	-	0.775	V
VR10 w/ Legacy SS/VR11 Threshold		2.7	-	3.1	V
Internal DAC Slew Rate Limiter					
Positive Slew Rate Limit	VID step range of +10mV to +500mV	-	7.3	-	mV/μs
Negative Slew Rate Limit	VID step range of -10mV to -500mV	-	7.3	-	mV/μs
Voltage Reference (V_{REF})					
V_{REF} Output Voltage	0 < I_{VREF} < 250 μA	3.92	4.00	4.08	V
Input Supply Current					
V_{CC} Operating Current	F_{SW} = 400 kHz	-	20	-	mA

ELECTRICAL CHARACTERISTICS
(0°C < T_A < 70°C; 0°C < T_J < 85°C; 10.8 V < V_{CC} < 13.2 V; All DAC Codes; C_{VCC} = 0.1 μF, F_{SW} = 400 kHz, unless otherwise stated)

Parameter	Test Conditions	Min	Typ	Max	Units
VR10 DAC					
System Voltage Accuracy	1.0 V < DAC < 1.6 V 0.8 V < DAC < 1.0 V 0.5 V < DAC < 0.8 V	-	-	±0.5 ±5.0 ±8.0	% mV mV
No-Load Offset Voltage from Nominal DAC Specification	With CS Input ΔVin = 0 V		-19		mV

VR10 VID Codes

VID4 400 mV	VID3 200 mV	VID2 100 mV	VID1 50 mV	VID0 25 mV	VID5 12.5 mV	VID6 6.25 mV	Nominal DAC Voltage (V)
0	1	0	1	0	1	1	1.60000
0	1	0	1	0	1	0	1.59375
0	1	0	1	1	0	1	1.58750
0	1	0	1	1	0	0	1.58125
0	1	0	1	1	1	1	1.57500
0	1	0	1	1	1	0	1.56875
0	1	1	0	0	0	1	1.56250
0	1	1	0	0	0	0	1.55625
0	1	1	0	0	1	1	1.55000
0	1	1	0	0	1	0	1.54375
0	1	1	0	1	0	1	1.53750
0	1	1	0	1	0	0	1.53125
0	1	1	0	1	1	1	1.52500
0	1	1	0	1	1	0	1.51875
0	1	1	1	0	0	1	1.51250
0	1	1	1	0	0	0	1.50625
0	1	1	1	0	1	1	1.50000
0	1	1	1	0	1	0	1.49375
0	1	1	1	1	0	1	1.48750
0	1	1	1	1	0	0	1.48125
0	1	1	1	1	1	1	1.47500
0	1	1	1	1	1	0	1.46875
1	0	0	0	0	0	1	1.46250
1	0	0	0	0	0	0	1.45625
1	0	0	0	0	1	1	1.45000
1	0	0	0	0	1	0	1.44375
1	0	0	0	1	0	1	1.43750
1	0	0	0	1	0	0	1.43125
1	0	0	0	1	1	1	1.42500
1	0	0	0	1	1	0	1.41875
1	0	0	1	0	0	1	1.41250
1	0	0	1	0	0	0	1.40625
1	0	0	1	0	1	1	1.40000
1	0	0	1	0	1	0	1.39375
1	0	0	1	1	0	1	1.38750
1	0	0	1	1	0	0	1.38125
1	0	0	1	1	1	1	1.37500

VR10 VID Codes

VID4 400 mV	VID3 200 mV	VID2 100 mV	VID1 50 mV	VID0 25 mV	VID5 12.5 mV	VID6 6.25 mV	Nominal DAC Voltage (V)
1	0	0	1	1	1	0	1.36875
1	0	1	0	0	0	1	1.36250
1	0	1	0	0	0	0	1.35625
1	0	1	0	0	1	1	1.35000
1	0	1	0	0	1	0	1.34375
1	0	1	0	1	0	1	1.33750
1	0	1	0	1	0	0	1.33125
1	0	1	0	1	1	1	1.32500
1	0	1	0	1	1	0	1.31875
1	0	1	1	0	0	1	1.31250
1	0	1	1	0	0	0	1.30625
1	0	1	1	0	1	1	1.30000
1	0	1	1	0	1	0	1.29375
1	0	1	1	1	0	1	1.28750
1	0	1	1	1	0	0	1.28125
1	0	1	1	1	1	1	1.27500
1	0	1	1	1	1	0	1.26875
1	1	0	0	0	0	1	1.26250
1	1	0	0	0	0	0	1.25625
1	1	0	0	0	1	1	1.25000
1	1	0	0	0	1	0	1.24375
1	1	0	0	1	0	1	1.23750
1	1	0	0	1	0	0	1.23125
1	1	0	0	1	1	1	1.22500
1	1	0	0	1	1	0	1.21875
1	1	0	1	0	0	1	1.21250
1	1	0	1	0	0	0	1.20625
1	1	0	1	0	1	1	1.20000
1	1	0	1	0	1	0	1.19375
1	1	0	1	1	0	1	1.18750
1	1	0	1	1	0	0	1.18125
1	1	0	1	1	1	1	1.17500
1	1	0	1	1	1	0	1.16875
1	1	1	0	0	0	1	1.16250
1	1	1	0	0	0	0	1.15625
1	1	1	0	0	1	1	1.15000
1	1	1	0	0	1	0	1.14375
1	1	1	0	1	0	1	1.13750
1	1	1	0	1	0	0	1.13125
1	1	1	0	1	1	1	1.12500
1	1	1	0	1	1	0	1.11875
1	1	1	1	0	0	1	1.11250
1	1	1	1	0	0	0	1.10625
1	1	1	1	0	1	1	1.10000
1	1	1	1	0	1	0	1.09375
1	1	1	1	1	0	1	OFF
1	1	1	1	1	0	0	OFF

VR10 VID Codes

VID4 400 mV	VID3 200 mV	VID2 100 mV	VID1 50 mV	VID0 25 mV	VID5 12.5 mV	VID6 6.25 mV	Nominal DAC Voltage (V)
1	1	1	1	1	1	1	OFF
1	1	1	1	1	1	0	OFF
0	0	0	0	0	0	1	1.08750
0	0	0	0	0	0	0	1.08125
0	0	0	0	0	1	1	1.07500
0	0	0	0	0	1	0	1.06875
0	0	0	0	1	0	1	1.06250
0	0	0	0	1	0	0	1.05625
0	0	0	0	1	1	1	1.05000
0	0	0	0	1	1	0	1.04375
0	0	0	1	0	0	1	1.03750
0	0	0	1	0	0	0	1.03125
0	0	0	1	0	1	1	1.02500
0	0	0	1	0	1	0	1.01875
0	0	0	1	1	0	1	1.01250
0	0	0	1	1	0	0	1.00625
0	0	0	1	1	1	1	1.00000
0	0	0	1	1	1	0	0.99375
0	0	1	0	0	0	1	0.98750
0	0	1	0	0	0	0	0.98125
0	0	1	0	0	1	1	0.97500
0	0	1	0	0	1	0	0.96875
0	0	1	0	1	0	1	0.96250
0	0	1	0	1	0	0	0.95625
0	0	1	0	1	1	1	0.95000
0	0	1	0	1	1	0	0.94375
0	0	1	1	0	0	1	0.93750
0	0	1	1	0	0	0	0.93125
0	0	1	1	0	1	1	0.92500
0	0	1	1	0	1	0	0.91875
0	0	1	1	1	0	1	0.91250
0	0	1	1	1	0	0	0.90625
0	0	1	1	1	1	1	0.90000
0	0	1	1	1	1	0	0.89375
0	1	0	0	0	0	1	0.88750
0	1	0	0	0	0	0	0.88125
0	1	0	0	0	1	1	0.87500
0	1	0	0	0	1	0	0.86875
0	1	0	0	1	0	1	0.86250
0	1	0	0	1	0	0	0.85625
0	1	0	0	1	1	1	0.85000
0	1	0	0	1	1	0	0.84375
0	1	0	1	0	0	1	0.83750
0	1	0	1	0	0	0	0.83125

ELECTRICAL CHARACTERISTICS
(0°C < T_A < 70°C; 0°C < T_J < 125°C; 10.8 V < V_{CC} < 13.2 V; All DAC Codes; C_{VCC} = 0.1 μF, unless otherwise stated)

Parameter	Test Conditions	Min	Typ	Max	Units
VR 11 DAC					
System Voltage Accuracy	1.0 V < DAC < 1.6 V 0.8 V < DAC < 1.0 V 0.5 V < DAC < 0.8 V	-	-	±0.5 ±5.0 ±8.0	% mV mV
No-Load Offset Voltage from Nominal DAC Specification	With CS Input ΔVin = 0 V		-19		mV

Table 2: VR11 VID Codes

VID7 800 mV	VID6 400 mV	VID5 200 mV	VID4 100 mV	VID3 50 mV	VID2 25 mV	VID1 12.5 mV	VID0 6.25 mV	Nominal DAC Voltage (V)	HEX
0	0	0	0	0	0	0	0	OFF	00
0	0	0	0	0	0	0	1	OFF	01
0	0	0	0	0	0	1	0	1.60000	02
0	0	0	0	0	0	1	1	1.59375	03
0	0	0	0	0	1	0	0	1.58750	04
0	0	0	0	0	1	0	1	1.58125	05
0	0	0	0	0	1	1	0	1.57500	06
0	0	0	0	0	1	1	1	1.56875	07
0	0	0	0	1	0	0	0	1.56250	08
0	0	0	0	1	0	0	1	1.55625	09
0	0	0	0	1	0	1	0	1.55000	0A
0	0	0	0	1	0	1	1	1.54375	0B
0	0	0	0	1	1	0	0	1.53750	0C
0	0	0	0	1	1	0	1	1.53125	0D
0	0	0	0	1	1	1	0	1.52500	0E
0	0	0	0	1	1	1	1	1.51875	0F
0	0	0	1	0	0	0	0	1.51250	10
0	0	0	1	0	0	0	1	1.50625	11
0	0	0	1	0	0	1	0	1.50000	12
0	0	0	1	0	0	1	1	1.49375	13
0	0	0	1	0	1	0	0	1.48750	14
0	0	0	1	0	1	0	1	1.48125	15
0	0	0	1	0	1	1	0	1.47500	16
0	0	0	1	0	1	1	1	1.46875	17
0	0	0	1	1	0	0	0	1.46250	18
0	0	0	1	1	0	0	1	1.45625	19
0	0	0	1	1	0	1	0	1.45000	1A
0	0	0	1	1	0	1	1	1.44375	1B
0	0	0	1	1	1	0	0	1.43750	1C
0	0	0	1	1	1	0	1	1.43125	1D
0	0	0	1	1	1	1	0	1.42500	1E
0	0	0	1	1	1	1	1	1.41875	1F
0	0	1	0	0	0	0	0	1.41250	20
0	0	1	0	0	0	0	1	1.40625	21
0	0	1	0	0	0	1	0	1.40000	22
0	0	1	0	0	0	1	1	1.39375	23
0	0	1	0	0	1	0	0	1.38750	24

Table 2: VR11 VID Codes

VID7 800 mV	VID6 400 mV	VID5 200 mV	VID4 100 mV	VID3 50 mV	VID2 25 mV	VID1 12.5 mV	VID0 6.25 mV	Nominal DAC Voltage (V)	HEX
0	0	1	0	0	1	0	1	1.38125	25
0	0	1	0	0	1	1	0	1.37500	26
0	0	1	0	0	1	1	1	1.36875	27
0	0	1	0	1	0	0	0	1.36250	28
0	0	1	0	1	0	0	1	1.35625	29
0	0	1	0	1	0	1	0	1.35000	2A
0	0	1	0	1	0	1	1	1.34375	2B
0	0	1	0	1	1	0	0	1.33750	2C
0	0	1	0	1	1	0	1	1.33125	2D
0	0	1	0	1	1	1	0	1.32500	2E
0	0	1	0	1	1	1	1	1.31875	2F
0	0	1	1	0	0	0	0	1.31250	30
0	0	1	1	0	0	0	1	1.30625	31
0	0	1	1	0	0	1	0	1.30000	32
0	0	1	1	0	0	1	1	1.29375	33
0	0	1	1	0	1	0	0	1.28750	34
0	0	1	1	0	1	0	1	1.28125	35
0	0	1	1	0	1	1	0	1.27500	36
0	0	1	1	0	1	1	1	1.26875	37
0	0	1	1	1	0	0	0	1.26250	38
0	0	1	1	1	0	0	1	1.25625	39
0	0	1	1	1	0	1	0	1.25000	3A
0	0	1	1	1	0	1	1	1.24375	3B
0	0	1	1	1	1	0	0	1.23750	3C
0	0	1	1	1	1	0	1	1.23125	3D
0	0	1	1	1	1	1	0	1.22500	3E
0	0	1	1	1	1	1	1	1.21875	3F
0	1	0	0	0	0	0	0	1.21250	40
0	1	0	0	0	0	0	1	1.20625	41
0	1	0	0	0	0	1	0	1.20000	42
0	1	0	0	0	0	1	1	1.19375	43
0	1	0	0	0	1	0	0	1.18750	44
0	1	0	0	0	1	0	1	1.18125	45
0	1	0	0	0	1	1	0	1.17500	46
0	1	0	0	0	1	1	1	1.16875	47
0	1	0	0	1	0	0	0	1.16250	48
0	1	0	0	1	0	0	1	1.15625	49
0	1	0	0	1	0	1	0	1.15000	4A
0	1	0	0	1	0	1	1	1.14375	4B
0	1	0	0	1	1	0	0	1.13750	4C
0	1	0	0	1	1	0	1	1.13125	4D
0	1	0	0	1	1	1	0	1.12500	4E
0	1	0	0	1	1	1	1	1.11875	4F
0	1	0	1	0	0	0	0	1.11250	50
0	1	0	1	0	0	0	1	1.10625	51
0	1	0	1	0	0	1	0	1.10000	52

Table 2: VR11 VID Codes

VID7 800 mV	VID6 400 mV	VID5 200 mV	VID4 100 mV	VID3 50 mV	VID2 25 mV	VID1 12.5 mV	VID0 6.25 mV	Nominal DAC Voltage (V)	HEX
0	1	0	1	0	0	1	1	1.09375	53
0	1	0	1	0	1	0	0	1.08750	54
0	1	0	1	0	1	0	1	1.08125	55
0	1	0	1	0	1	1	0	1.07500	56
0	1	0	1	0	1	1	1	1.06875	57
0	1	0	1	1	0	0	0	1.06250	58
0	1	0	1	1	0	0	1	1.05625	59
0	1	0	1	1	0	1	0	1.05000	5A
0	1	0	1	1	0	1	1	1.04375	5B
0	1	0	1	1	1	0	0	1.03750	5C
0	1	0	1	1	1	0	1	1.03125	5D
0	1	0	1	1	1	1	0	1.02500	5E
0	1	0	1	1	1	1	1	1.01875	5F
0	1	1	0	0	0	0	0	1.01250	60
0	1	1	0	0	0	0	1	1.00625	61
0	1	1	0	0	0	1	0	1.00000	62
0	1	1	0	0	0	1	1	0.99375	63
0	1	1	0	0	1	0	0	0.98750	64
0	1	1	0	0	1	0	1	0.98125	65
0	1	1	0	0	1	1	0	0.97500	66
0	1	1	0	0	1	1	1	0.96875	67
0	1	1	0	1	0	0	0	0.96250	68
0	1	1	0	1	0	0	1	0.95625	69
0	1	1	0	1	0	1	0	0.95000	6A
0	1	1	0	1	0	1	1	0.94375	6B
0	1	1	0	1	1	0	0	0.93750	6C
0	1	1	0	1	1	0	1	0.93125	6D
0	1	1	0	1	1	1	0	0.92500	6E
0	1	1	0	1	1	1	1	0.91875	6F
0	1	1	1	0	0	0	0	0.91250	70
0	1	1	1	0	0	0	1	0.90625	71
0	1	1	1	0	0	1	0	0.90000	72
0	1	1	1	0	0	1	1	0.89375	73
0	1	1	1	0	1	0	0	0.88750	74
0	1	1	1	0	1	0	1	0.88125	75
0	1	1	1	0	1	1	0	0.87500	76
0	1	1	1	0	1	1	1	0.86875	77
0	1	1	1	1	0	0	0	0.86250	78
0	1	1	1	1	0	0	1	0.85625	79
0	1	1	1	1	0	1	0	0.85000	7A
0	1	1	1	1	0	1	1	0.84375	7B
0	1	1	1	1	1	0	0	0.83750	7C
0	1	1	1	1	1	0	1	0.83125	7D
0	1	1	1	1	1	1	0	0.82500	7E
0	1	1	1	1	1	1	1	0.81875	7F
1	0	0	0	0	0	0	0	0.81250	80

Table 2: VR11 VID Codes

VID7 800 mV	VID6 400 mV	VID5 200 mV	VID4 100 mV	VID3 50 mV	VID2 25 mV	VID1 12.5 mV	VID0 6.25 mV	Nominal DAC Voltage (V)	HEX
1	0	0	0	0	0	0	1	0.80625	81
1	0	0	0	0	0	1	0	0.80000	82
1	0	0	0	0	0	1	1	0.79375	83
1	0	0	0	0	1	0	0	0.78750	84
1	0	0	0	0	1	0	1	0.78125	85
1	0	0	0	0	1	1	0	0.77500	86
1	0	0	0	0	1	1	1	0.76875	87
1	0	0	0	1	0	0	0	0.76250	88
1	0	0	0	1	0	0	1	0.75625	89
1	0	0	0	1	0	1	0	0.75000	8A
1	0	0	0	1	0	1	1	0.74375	8B
1	0	0	0	1	1	0	0	0.73750	8C
1	0	0	0	1	1	0	1	0.73125	8D
1	0	0	0	1	1	1	0	0.72500	8E
1	0	0	0	1	1	1	1	0.71875	8F
1	0	0	1	0	0	0	0	0.71250	90
1	0	0	1	0	0	0	1	0.70625	91
1	0	0	1	0	0	1	0	0.70000	92
1	0	0	1	0	0	1	1	0.69375	93
1	0	0	1	0	1	0	0	0.68750	94
1	0	0	1	0	1	0	1	0.68125	95
1	0	0	1	0	1	1	0	0.67500	96
1	0	0	1	0	1	1	1	0.66875	97
1	0	0	1	1	0	0	0	0.66250	98
1	0	0	1	1	0	0	1	0.65625	99
1	0	0	1	1	0	1	0	0.65000	9A
1	0	0	1	1	0	1	1	0.64375	9B
1	0	0	1	1	1	0	0	0.63750	9C
1	0	0	1	1	1	0	1	0.63125	9D
1	0	0	1	1	1	1	0	0.62500	9E
1	0	0	1	1	1	1	1	0.61875	9F
1	0	1	0	0	0	0	0	0.61250	A0
1	0	1	0	0	0	0	1	0.60625	A1
1	0	1	0	0	0	1	0	0.60000	A2
1	0	1	0	0	0	1	1	0.59375	A3
1	0	1	0	0	1	0	0	0.58750	A4
1	0	1	0	0	1	0	1	0.58125	A5
1	0	1	0	0	1	1	0	0.57500	A6
1	0	1	0	0	1	1	1	0.56875	A7
1	0	1	0	1	0	0	0	0.56250	A8
1	0	1	0	1	0	0	1	0.55625	A9
1	0	1	0	1	0	1	0	0.55000	AA
1	0	1	0	1	0	1	1	0.54375	AB
1	0	1	0	1	1	0	0	0.53750	AC
1	0	1	0	1	1	0	1	0.53125	AD
1	0	1	0	1	1	1	0	0.52500	AE

Table 2: VR11 VID Codes

VID7 800 mV	VID6 400 mV	VID5 200 mV	VID4 100 mV	VID3 50 mV	VID2 25 mV	VID1 12.5 mV	VID0 6.25 mV	Nominal DAC Voltage (V)	HEX
1	0	1	0	1	1	1	1	0.51875	AF
1	0	1	1	0	0	0	0	0.51250	B0
1	0	1	1	0	0	0	1	0.50625	B1
1	0	1	1	0	0	1	0	0.50000	B2
1	1	1	1	1	1	1	0	OFF	FE
1	1	1	1	1	1	1	1	OFF	FF
								OFF	B3 to FD

TYPICAL CHARACTERISTICS

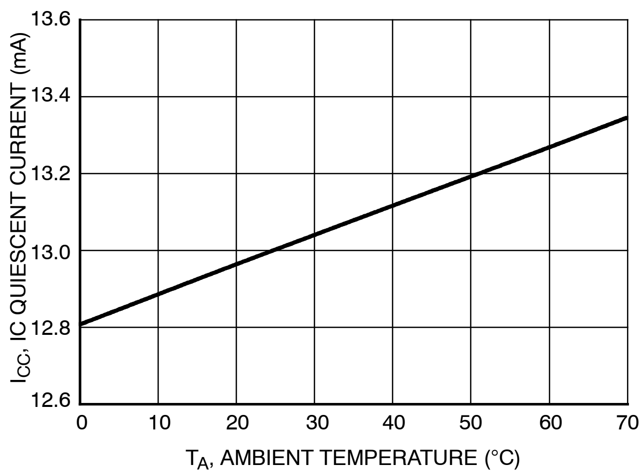


Figure 5. IC Quiescent Current vs. Ambient Temperature

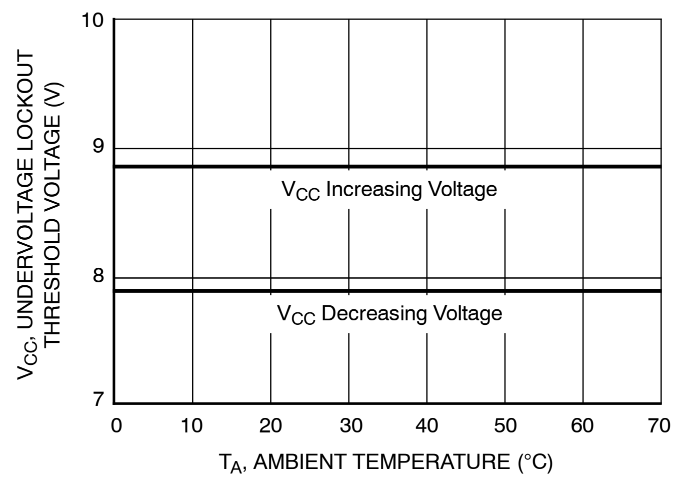


Figure 6. VCC Undervoltage Lockout Threshold Voltage vs. Ambient Temperature

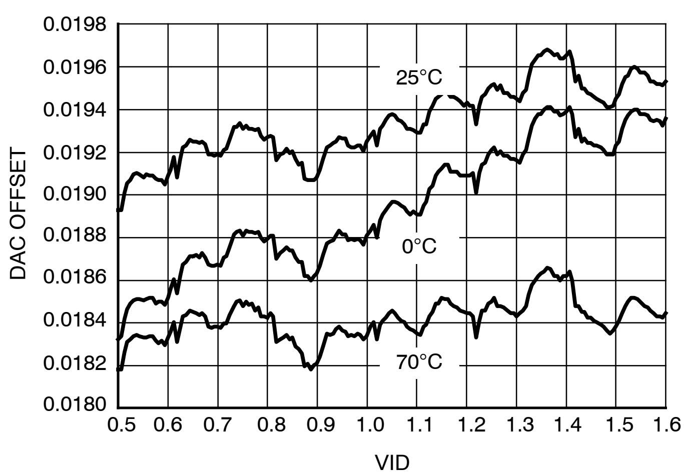


Figure 7. Typical DAC Voltage Offset vs. Temperature

FUNCTIONAL DESCRIPTION

General

The NCP5381A dual edge modulated multiphase PWM controller is specifically designed with the necessary features for a high current VR10 or VR11 CPU power system. The IC consists of the following blocks: Precision Programmable DAC, Differential Remote Voltage Sense Amplifier, High Performance Voltage Error Amplifier, Differential Current Feedback Amplifiers, Precision Oscillator and Triangle Wave Generators, and PWM Comparators. Protection features include Undervoltage Lockout, Soft-Start, Overcurrent Protection, Overvoltage Protection, and Power Good Monitor.

Remote Output Sensing Amplifier (RSA)

A true differential amplifier allows the NCP5381A to measure Vcore voltage feedback with respect to the Vcore ground reference point by connecting the Vcore reference point to VS+, and the Vcore ground reference point to VS-. This configuration keeps ground potential differences between the local controller ground and the Vcore ground reference point from affecting regulation of Vcore between Vcore and Vcore ground reference points. The RSA also subtracts the DAC (minus VID offset) voltage, thereby producing an unamplified output error voltage at the DIFFOUT pin. This output also has a 1.3 V bias voltage to allow both positive and negative error voltages.

Precision Programmable DAC

A precision programmable DAC is provided. This DAC has 0.5% accuracy over the entire operating temperature range of the part. The DAC can be programmed to support either VR10 or VR11 specifications. A program selection pin is provided to accomplish this. This pin also sets the startup mode of operation. Connect this pin to 1.25 V to select the VR11 DAC table, and the VR11 startup mode. Connect this pin to ground to select the VR10 DAC table and the VR11 startup mode. Connect this pin to VREF to select the VR10 DAC table and the VR10 startup mode.

High Performance Voltage Error Amplifier

The error amplifier is designed to provide high slew rate and bandwidth. Although not required when operating as a voltage regulator for VR10 or VR11, a capacitor from COMP to VFB is required for stable unity gain test configurations.

Gate Driver Outputs and 2/3/4 Phase Operation

The part can be configured to run in 2-, 3-, or 4-phase mode. In 2-phase mode, phases 1 and 3 should be used to drive the external gate drivers as shown in the 2-phase Applications Schematic. In 3-phase mode, gate output G4 must be grounded as shown in the 3-phase Applications Schematic. In 4-phase mode all 4 gate outputs are used as shown in the 4-phase Applications Schematic. The following truth table summarizes the modes of operation:

Mode	Gate Output Connections			
	G1	G2	G3	G4
2-Phase	Normal	**OPEN**	Normal	**OPEN**
3-Phase	Normal	Normal	Normal	**GND**
4-Phase	Normal	Normal	Normal	Normal

These are the only allowable connection schemes to program the modes of operation.

Differential Current Sense Amplifiers

Four differential amplifiers are provided to sense the output current of each phase. The inputs of each current sense amplifier must be connected across the current sensing element of the phase controlled by the corresponding gate output (G1, G2, G3, or G4). **If a phase is unused, the differential inputs to that phase's current sense amplifier must be shorted together and connected to V_{CCP} as shown in the 2- and 3-phase Application Schematics**.

A voltage is generated across the current sense element (such as an inductor or sense resistor) by the current flowing in that phase. The output of the current sense amplifiers are used to control three functions. First, the output controls the adaptive voltage positioning, where the output voltage is actively controlled according to the output current. In this function, all of the current sense outputs are summed so that the total output current is used for output voltage positioning. Second, the output signal is fed to the current limit circuit. This again is the summed current of all phases in operation. Finally, the individual phase current is connected to the PWM comparator. In this way current balance is accomplished.

Oscillator and Triangle Wave Generator

A programmable precision oscillator is provided. The oscillator's frequency is programmed by the resistance connected from the ROSC pin to ground. The user will usually form this resistance from two resistors in order to create a voltage divider that uses the ROSC output voltage as the reference for creating the current limit setpoint voltage. The oscillator frequency range is 100 kHz/phase to 1.0 MHz/phase. The oscillator generates up to 4 triangle waveforms (symmetrical rising and falling slopes) between 1.3 V and 2.3 V. The triangle waves have a phase delay between them such that for 2-, 3-, and 4-phase operation the PWM outputs are separated by 180, 120, and 90 angular degrees, respectively.

PWM Comparators with Hysteresis

Four PWM comparators receive the error amplifier output signal at their noninverting input. Each comparator receives one of the triangle waves offset by 1.3 V at it's inverting input. The output of the comparator generates the PWM outputs G1, G2, G3, and G4.

During steady state operation, the duty cycle will center on the valley of the triangle waveform, with steady state duty cycle calculated by V_{out}/V_{in}. During a transient event, both high and low comparator output transitions shift phase to the points where the error amplifier output intersects the down and up ramp of the triangle wave.

PROTECTION FEATURES

Undervoltage Lockout

An undervoltage lockout (UVLO) senses the VCC input. During powerup, the input voltage to the controller is monitored, and the PWM outputs and the soft-start circuit are disabled until the input voltage exceeds the threshold voltage of the UVLO comparator. The UVLO comparator incorporates hysteresis to avoid chattering, since VCC is likely to decrease as soon as the converter initiates soft-start.

Overcurrent Shutdown

A programmable overcurrent function is incorporated within the IC. A comparator and latch makeup this function. The inverting input of the comparator is connected to the ILIM pin. The voltage at this pin sets the maximum output current the converter can produce. The ROSC pin provides a convenient and accurate reference voltage from which a resistor divider can create the overcurrent setpoint voltage. Although not actually disabled, tying the ILIM pin directly to the ROSC pin sets the limit above useful levels – effectively disabling overcurrent shutdown. The comparator noninverting input is the summed current information from the current sense amplifiers. The overcurrent latch is set when the current information exceeds the voltage at the ILIM pin. The outputs are immediately disabled, the VR_RDY and DRVON pins are pulled low, and the soft-start is pulled low. The outputs will remain disabled until the V_{CC} voltage is removed and re-applied, or the ENABLE input is brought low and then high.

Overvoltage Protection and Power Good Monitor

An output voltage monitor is incorporated. During normal operation, if the voltage at the DIFFOUT pin exceeds 1.3 V, the VR_RDY pin goes low, the DRVON signal remains high, the PWM outputs are set low. The outputs will remain disabled until the V_{CC} voltage is removed and reapplied. During normal operation, if the output voltage falls more than 300 mV below the DAC setting, the VR_RDY pin will be set low until the output rises.

Soft-Start

The NCP5381A incorporates an externally programmable soft-start. The soft-start circuit works by controlling the ramp-up of the DAC voltage during powerup. The initial soft-start pin voltage is 0 V. The soft-start circuitry clamps the DAC input of the Remote Sense Amplifier to the SS pin voltage until the SS pin voltage exceeds the DAC setting minus VID offset. The soft-start pin is pulled to 0 V if there is an overcurrent shutdown, if the ENABLE pin is low, if V_{CC} is below the UVLO threshold, or if an overvoltage condition exists.

There are two possible soft-start modes: Legacy VR10 and VR11. VR10 mode simply ramps Vcore from 0 V directly to the DAC setting at the rate set by the capacitor connected to the SS pin. The VR11 mode ramps Vcore to 1.1 V at the SS capacitor charge rate, pauses at 1.1 V for 170 μs, reads the VID pins to determine the DAC setting, then ramps Vcore to the final DAC setting at the Dynamic VID slew rate of 7.3 mV/μs. Typical VR10 and VR11 soft-start sequences are shown in the following graphs.

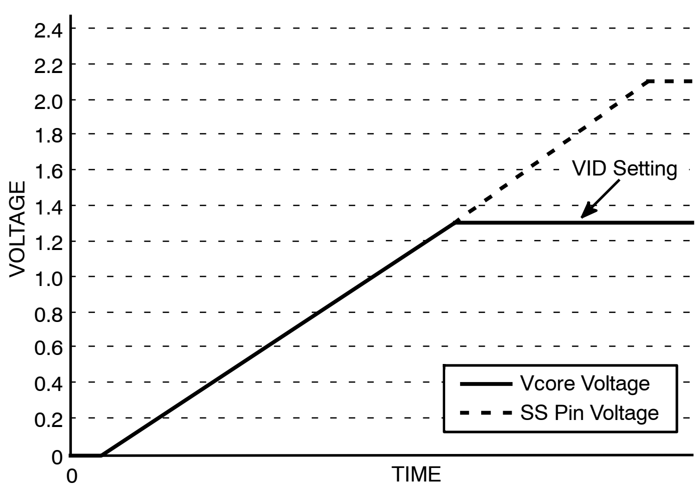


Figure 8. Typical VR10 Soft-Start Sequence to Vcore = 1.3 V